

**Search Notes**

Application No.

10/615,846

Examiner

Stephen W. Smoot

**Applicant(s)**

NAKAYAMA, HIROHISA

Art Unit

2813

<b>SEARCHED</b>			
Class	Subclass	Date	Examiner
438	123	8/3/2004	SWS
438	124	8/3/2004	SWS
438	125	8/3/2004	SWS
438	126	8/3/2004	SWS
438	127	8/3/2004	SWS
438	617	8/3/2004	SWS
257	671	8/3/2004	SWS
257	690	8/3/2004	SWS
257	735	8/3/2004	SWS
257	784	8/3/2004	SWS
257	787	8/3/2004	SWS

<b>SEARCH NOTES (INCLUDING SEARCH STRATEGY)</b>		
	DATE	EXMR
Key Words: Lead Frame; Bond wires; Mold, Seal, Encapsulate;	8/3/2004	SWS
Sheet - Flexible, Tie Bar, Dam Bar, Die Pad, Die Paddle.	8/3/2004	SWS
Search Tools - EAST (attached): USPAT; US PG PUBS; Derwent; EPO; JPO; IBM TDB	8/3/2004	SWS

<b>INTERFERENCE SEARCHED</b>			
Class	Subclass	Date	Examiner